

$V_{DSS}$	30V
$R_{DS(on)}(Max.)$	11.7mΩ
$I_D$	±10A
$P_D$	2W

### ●Features

- 1) Low on - resistance.
- 2) High power package (HSMT8).
- 3) Pb-free lead plating ; RoHS compliant
- 4) Halogen free
- 5) 100% Rg and UIS tested.

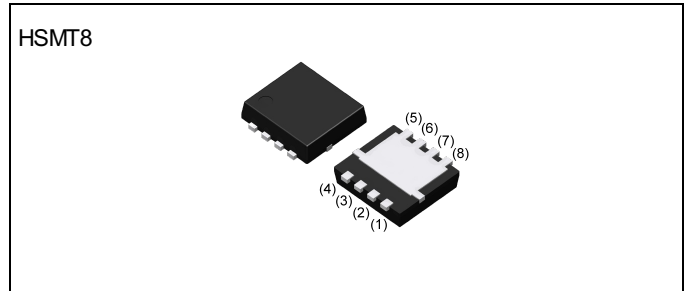
### ●Application

Switching

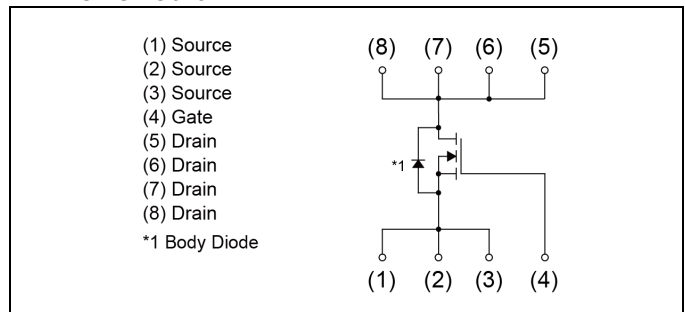
### ●Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

Parameter	Symbol	Value	Unit	
Drain - Source voltage	$V_{DSS}$	30	V	
Continuous drain current	$T_c = 25^{\circ}C$	$I_D^{*1}$	±14	A
	$T_a = 25^{\circ}C$	$I_D$	±10	A
Pulsed drain current	$I_{D,pulse}^{*2}$	±40	A	
Gate - Source voltage	$V_{GSS}$	±20	V	
Avalanche energy, single pulse	$E_{AS}^{*3}$	7.6	mJ	
Avalanche current	$I_{AS}^{*3}$	10	A	
Power dissipation	$P_D^{*1}$	15	W	
	$P_D^{*4}$	2	W	
Junction temperature	$T_j$	150	°C	
Range of storage temperature	$T_{stg}$	-55 to +150	°C	

### ●Outline



### ●Inner circuit



### ●Packaging specifications

Type	Packing	Embossed Tape
	Reel size (mm)	330
	Tape width (mm)	12
	Basic ordering unit (pcs)	3000
	Taping code	TB
	Marking	E100GN

### ● Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - ambient	$R_{thJA}^{*4}$	-	-	62.5	°C/W
Thermal resistance, junction - case	$R_{thJC}^{*1}$	-	-	8.2	°C/W

### ● Electrical characteristics ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	30	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	$I_D = 1mA$ referenced to $25^\circ\text{C}$	-	28	-	mV/°C
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 24V, V_{GS} = 0V$	-	-	1	$\mu\text{A}$
Gate - Source leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 1mA$	1.2	-	2.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$	$I_D = 1mA$ referenced to $25^\circ\text{C}$	-	-3.87	-	mV/°C
Static drain - source on - state resistance	$R_{DS(on)}^{*5}$	$V_{GS} = 10V, I_D = 10A$	-	8.9	11.7	m $\Omega$
		$V_{GS} = 4.5V, I_D = 10A$	-	12.0	15.7	
Gate input resistance	$R_G$	f=1MHz, open drain	-	2.4	-	$\Omega$
Forward Transfer Admittance	$ Y_{fs} ^{*5}$	$V_{DS} = 5V, I_D = 10A$	8	-	-	S

\*1  $T_c = 25^\circ\text{C}$

\*2  $P_w \leq 10\mu\text{s}$ , Duty cycle  $\leq 1\%$

\*3  $L \approx 0.1\text{mH}$ ,  $V_{DD} = 15V$ ,  $R_G = 25\Omega$ , STARTING  $T_j = 25^\circ\text{C}$  Fig.3-1,3-2

\*4 Mounted on a ceramic board (30×30×0.8mm)

\*5 Pulsed

**●Electrical characteristics** ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Input capacitance	$C_{iss}$	$V_{GS} = 0V$	-	420	-	pF
Output capacitance	$C_{oss}$	$V_{DS} = 15V$	-	120	-	
Reverse transfer capacitance	$C_{rss}$	$f = 1\text{MHz}$	-	32	-	
Turn - on delay time	$t_{d(on)}^{*5}$	$V_{DD} \approx 15V, V_{GS} = 10V$	-	8.4	-	ns
Rise time	$t_r^{*5}$	$I_D = 5A$	-	4.3	-	
Turn - off delay time	$t_{d(off)}^{*5}$	$R_L \approx 3\Omega$	-	22.4	-	
Fall time	$t_f^{*5}$	$R_G = 10\Omega$	-	3.1	-	

**●Gate charge characteristics** ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Conditions	Values			Unit	
			Min.	Typ.	Max.		
Total gate charge	$Q_g^{*5}$	$V_{DD} \approx 15V$ $I_D = 10A$	$V_{GS} = 10V$	-	7.9	-	nC
Gate - Source charge	$Q_{gs}^{*5}$		$V_{GS} = 4.5V$	-	3.9	-	
Gate - Drain charge	$Q_{gd}^{*5}$			-	2.1	-	
				-	0.8	-	

**●Body diode electrical characteristics** (Source-Drain) ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Body diode continuous forward current	$I_S$	$T_a = 25^\circ\text{C}$	-	-	1.67	A
Body diode pulse current	$I_{SP}^{*2}$		-	-	40	A
Forward voltage	$V_{SD}^{*5}$	$V_{GS} = 0V, I_S = 1.67A$	-	-	1.2	V
Reverse recovery time	$t_{rr}^{*5}$	$I_S = 10A, V_{GS} = 0V$	-	18.5	-	ns
Reverse recovery charge	$Q_{rr}^{*5}$	$di/dt = 100A/\mu s$	-	8.9	-	nC

● Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

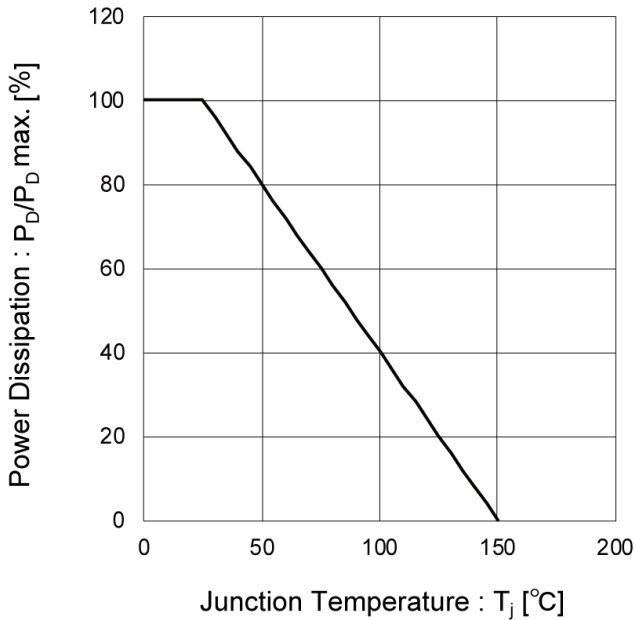


Fig.2 Maximum Safe Operating Area

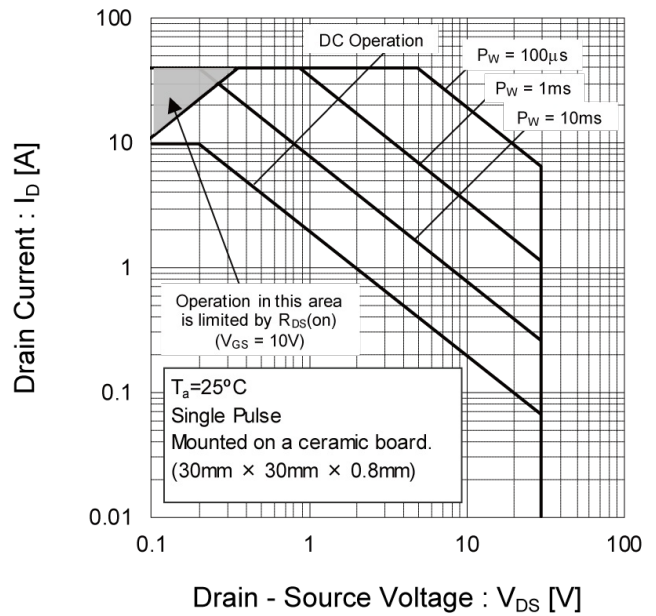


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

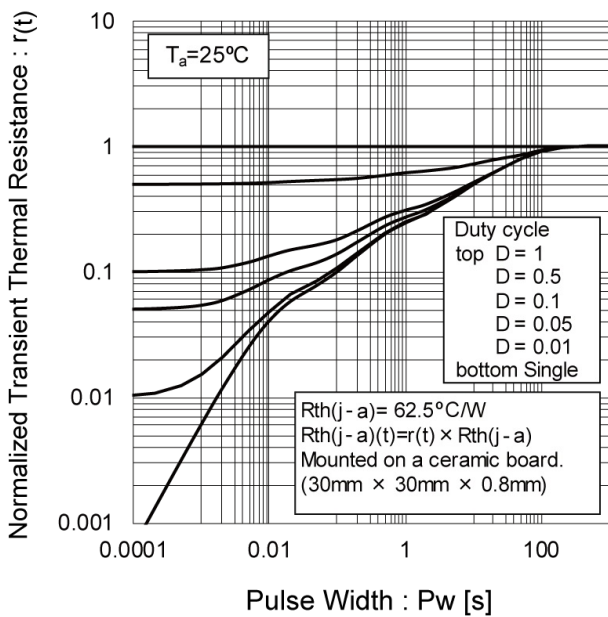
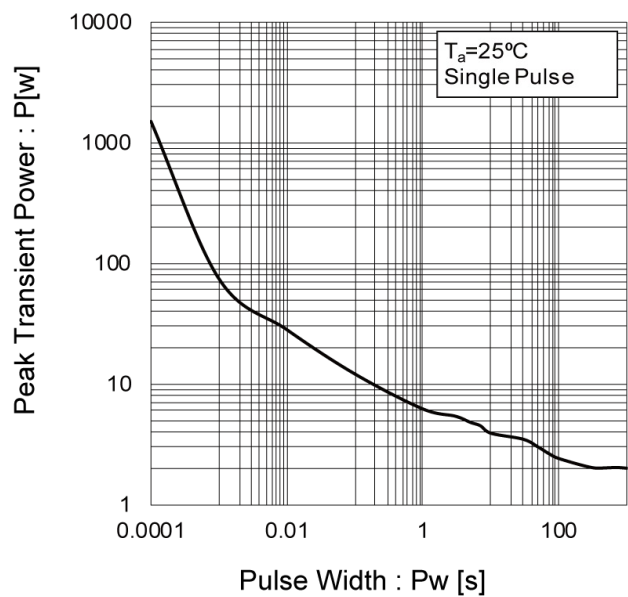


Fig.4 Single Pulse Maximum Power dissipation



● Electrical characteristic curves

Fig.5 Typical Output Characteristics(I)

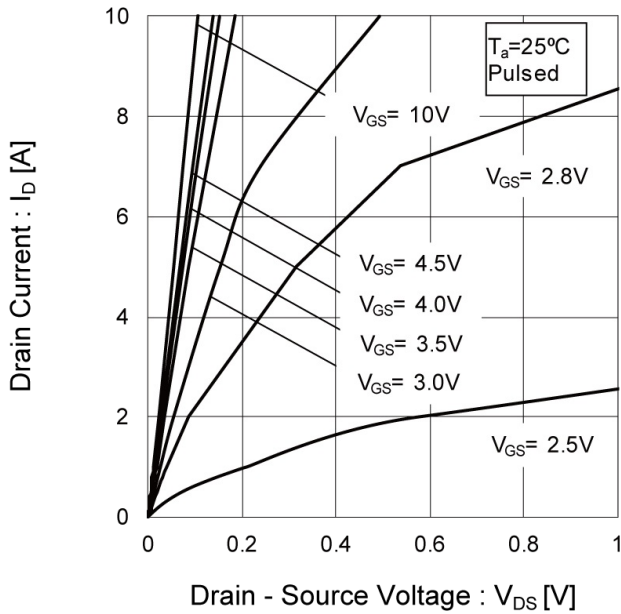


Fig.6 Typical Output Characteristics(II)

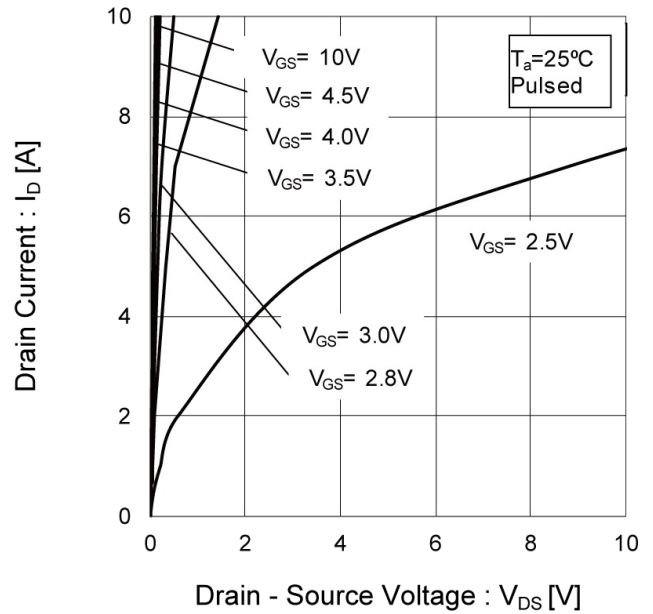


Fig.7 Breakdown Voltage vs. Junction Temperature

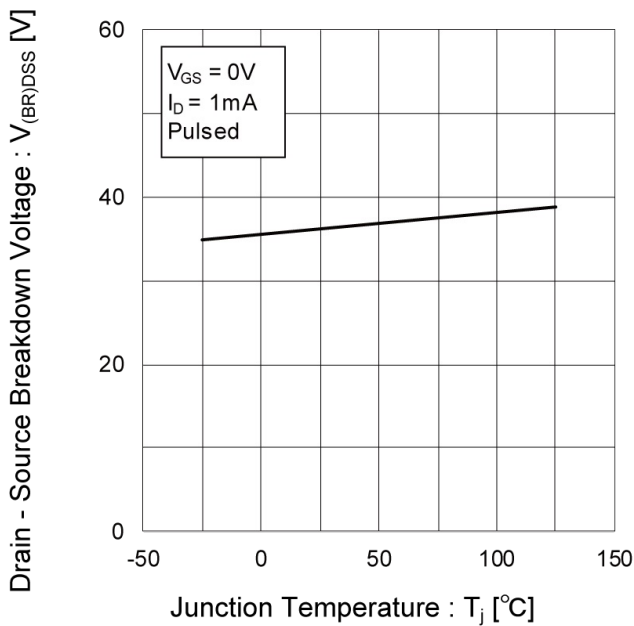
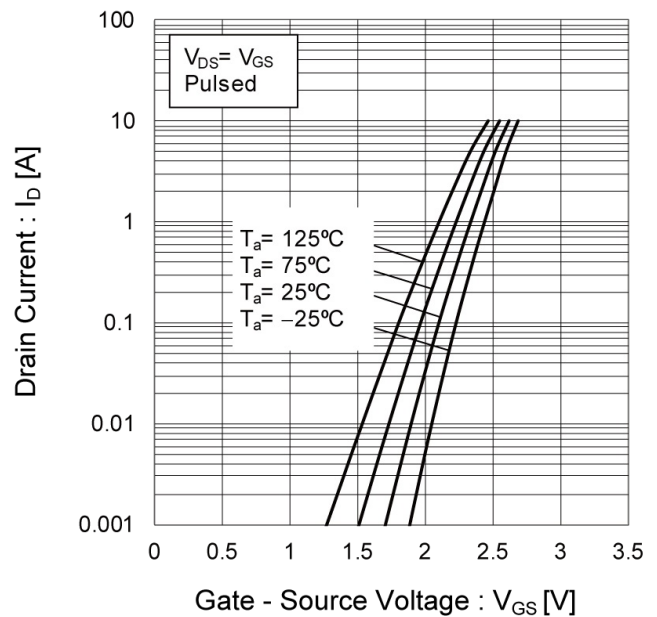


Fig.8 Typical Transfer Characteristics



● Electrical characteristic curves

Fig.9 Gate Threshold Voltage vs. Junction Temperature

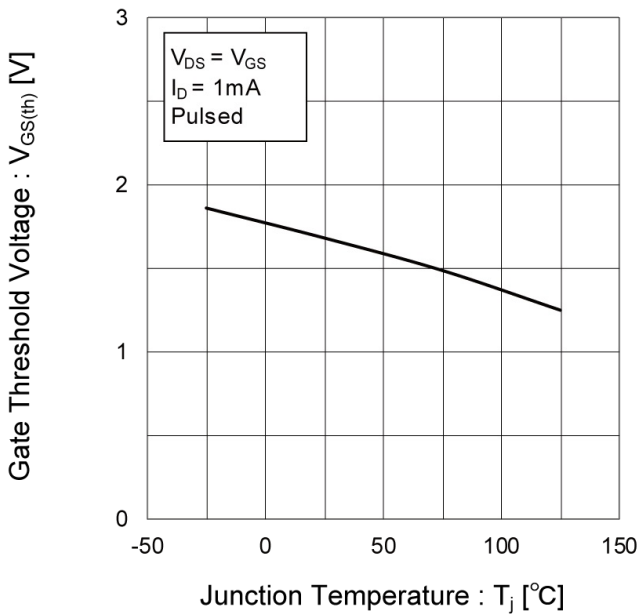


Fig.10 Forward Transfer Admittance vs. Drain Current

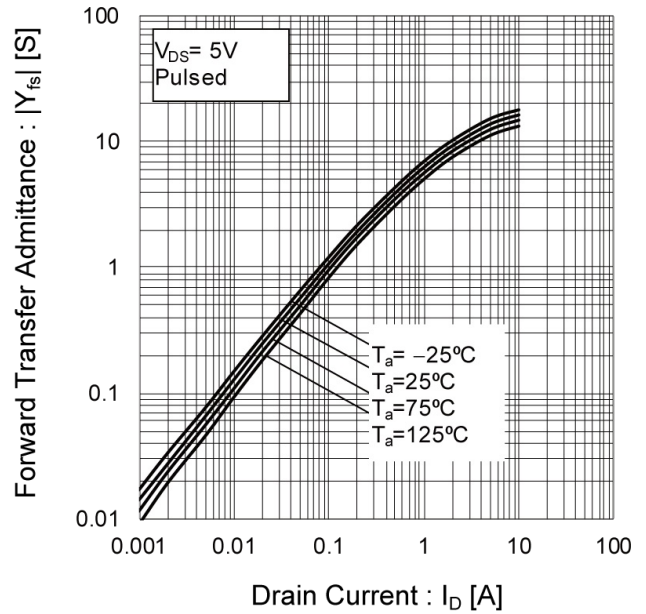


Fig.11 Drain Current Derating Curve

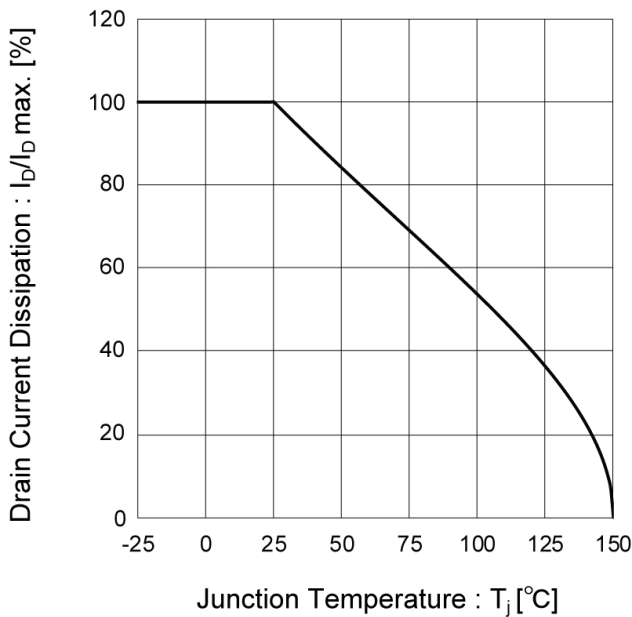
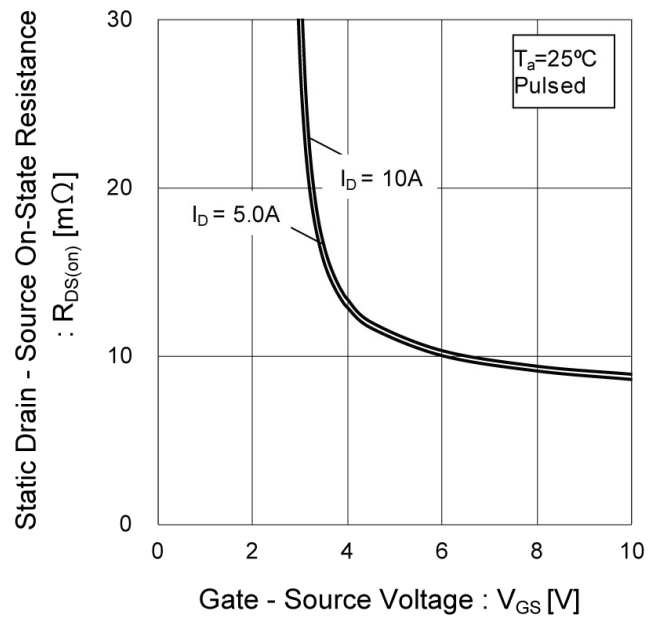


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage



● Electrical characteristic curves

Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

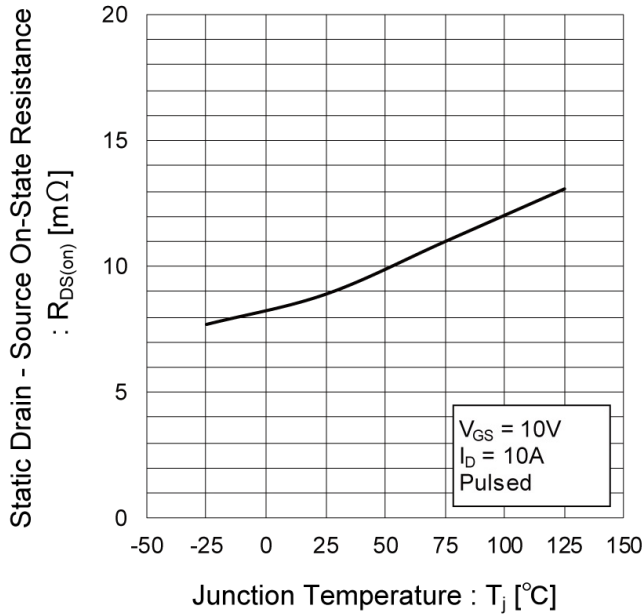


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current (I)

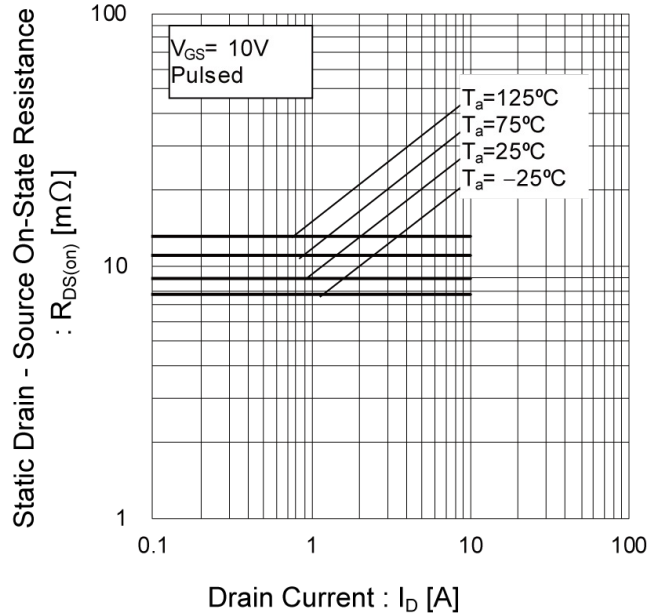
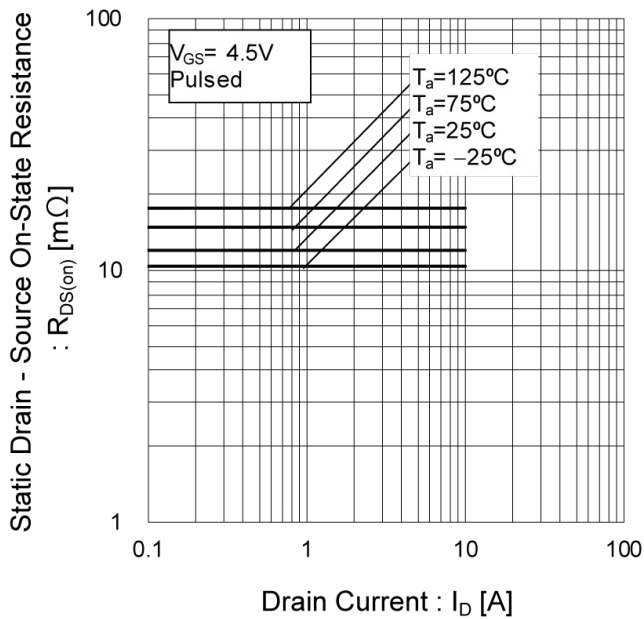


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)



● Electrical characteristic curves

Fig.16 Typical Capacitance vs. Drain - Source Voltage

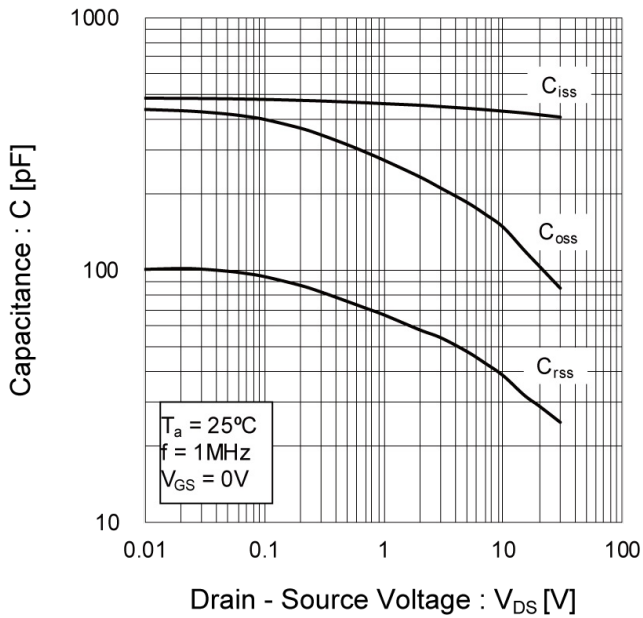


Fig.17 Switching Characteristics

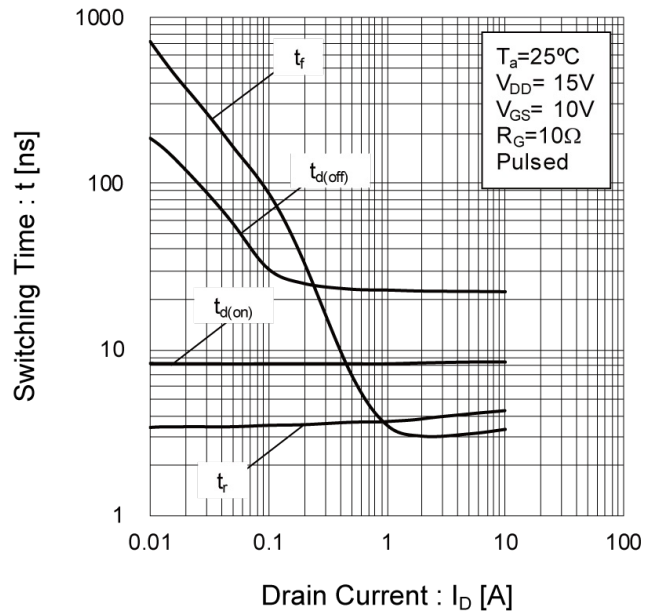


Fig.18 Dynamic Input Characteristics

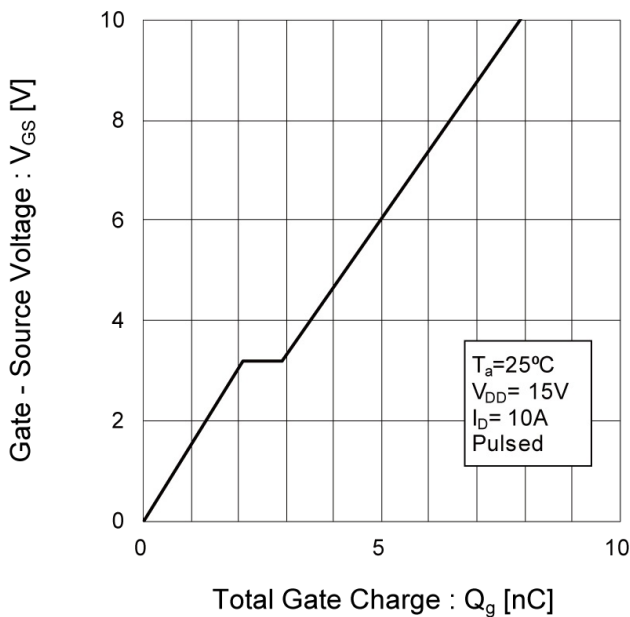
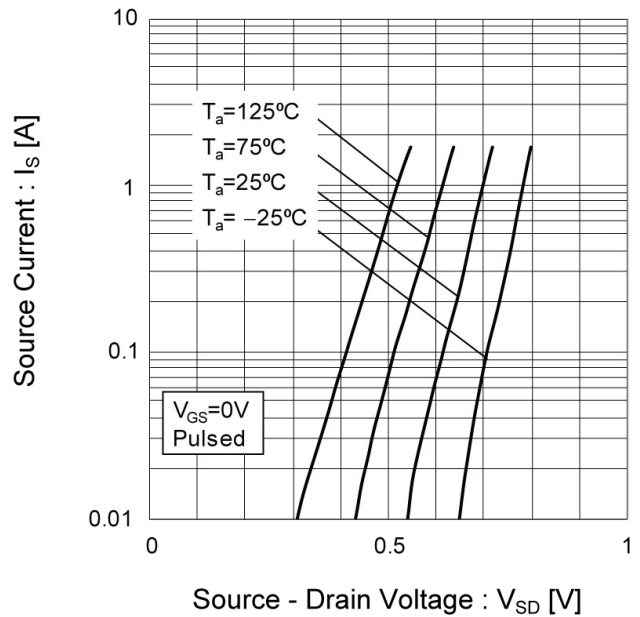


Fig.19 Source Current vs. Source Drain Voltage





● Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

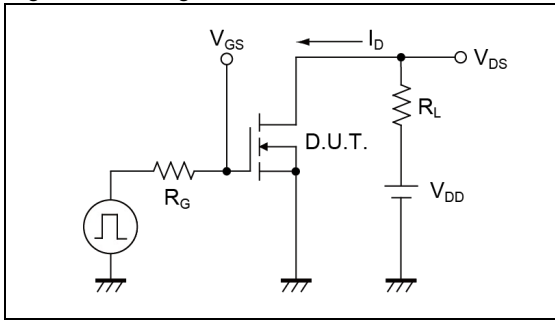


Fig.1-2 Switching Waveforms

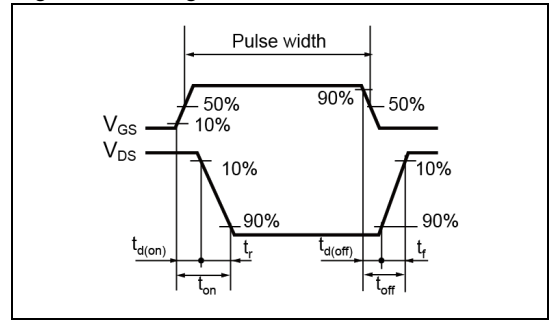


Fig.2-1 Gate Charge Measurement Circuit

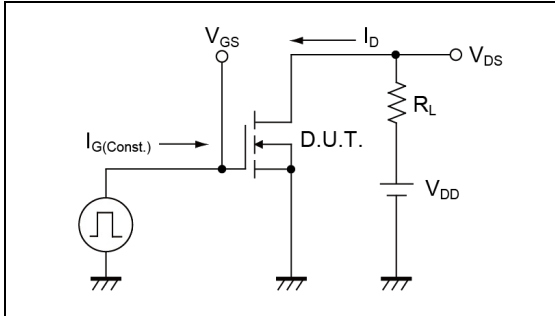


Fig.2-2 Gate Charge Waveform

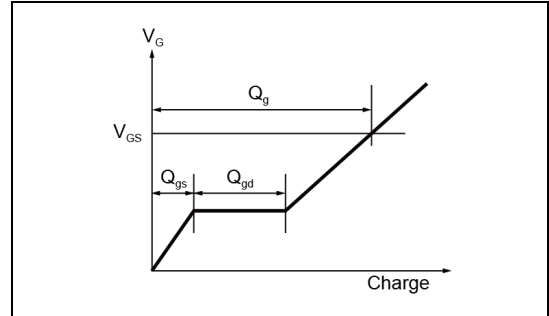


Fig.3-1 Avalanche Measurement Circuit

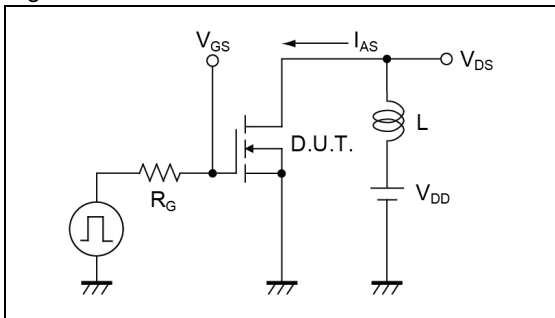
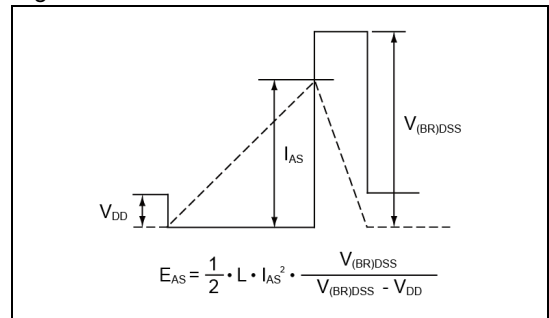


Fig.3-2 Avalanche Waveform

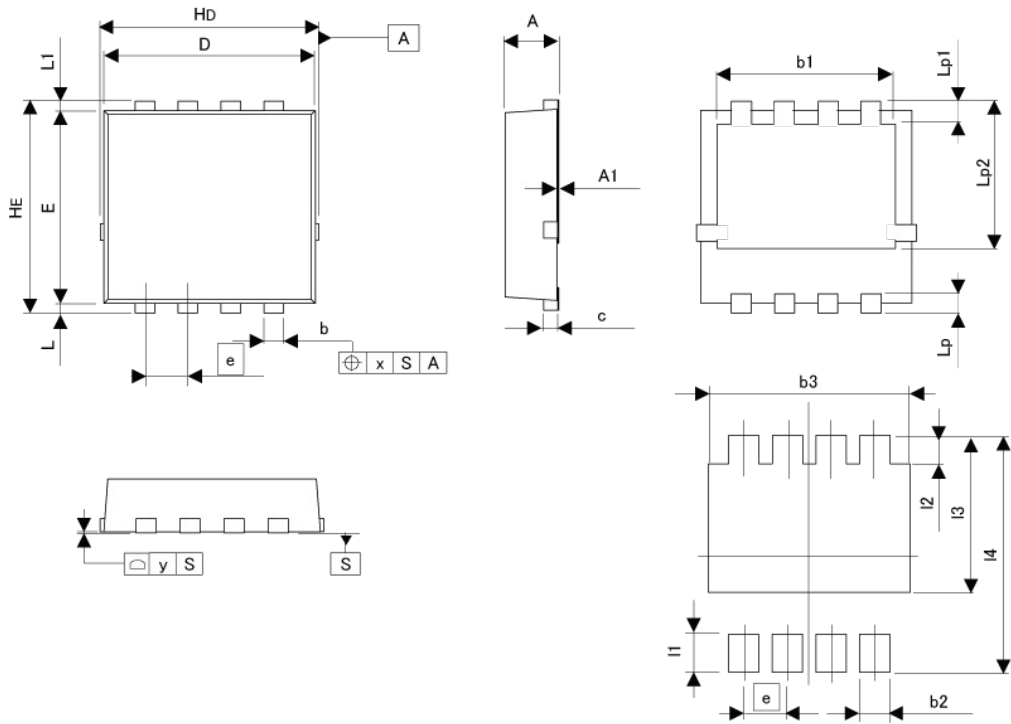


● Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

●Dimensions

HSMT8  
(3.3x3.3)



Pattern of terminal position areas  
[Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.70	0.90	0.028	0.035
A1	0.00	0.05	0.000	0.002
b	0.27	0.37	0.011	0.015
b1	2.50	2.70	0.098	0.106
c	0.10	0.30	0.004	0.012
D	3.10	3.30	0.122	0.130
E	2.90	3.10	0.114	0.122
e	0.65		0.026	
HD	3.20	3.40	0.126	0.134
HE	3.20	3.40	0.126	0.134
L	0.07	0.25	0.003	0.010
L1	0.07	0.25	0.003	0.010
Lp	0.20	0.40	0.008	0.016
Lp1	0.25	0.45	0.010	0.018
Lp2	2.20	2.40	0.087	0.094
x	-	0.10	-	0.004
y	-	0.10	-	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	-	0.47	-	0.019
b3	-	2.70	-	0.106
I1	-	0.50	-	0.020
I2	-	0.55	-	0.022
I3	-	2.40	-	0.094
I4	-	3.40	-	0.134

Dimension in mm/inches

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